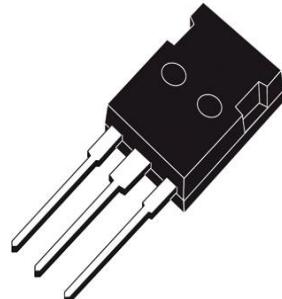


## IGBT

### Features

- 1200V,50A
- $V_{CE(sat)(typ.)}=2.1V @ V_{GE}=15V, I_C=50A$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology



TO-247-3L Plus

### General Description

JIAEN NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating), UPS, general inverter and other soft switching applications.

### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 30$	V
$I_C$	Continuous Collector Current ( $T_c=25^\circ C$ )	80	A
	Continuous Collector Current ( $T_c=100^\circ C$ )	50	A
$I_{CM}$	Pulsed Collector Current (Note 1)	150	A
$I_F$	Diode Continuous Forward Current ( $T_c=100^\circ C$ )	50	A
$I_{FM}$	Diode Maximum Forward Current (Note 1)	150	A
$t_{sc}$	Short Circuit Withstand Time $V_{GE} = 15V, V_{cc} \leq 960V, T_j \leq 150^\circ C$ ;	10	us
$P_D$	Maximum Power Dissipation ( $T_c=25^\circ C$ )	320	W
	Maximum Power Dissipation ( $T_c=100^\circ C$ )	130	W
$T_J$	Operating Junction Temperature Range	-55 to +150	°C
$T_{STG}$	Storage Temperature Range	-55 to +150	°C

### Thermal Characteristics

Symbol	Parameter	Max.	Units
$R_{th j-c}$	Thermal Resistance, Junction to case for IGBT	0.38	°C/W
$R_{th j-c}$	Thermal Resistance, Junction to case for Diode	0.5	°C/W
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	40	°C/W

## Electrical Characteristics ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C= 250\mu A$	1200	-	-	V
$I_{CES}$	Collector-Emitter Leakage Current	$V_{CE}= 1200V, V_{GE}= 0V$	-	-	250	$\mu A$
$I_{GES}$	Gate Leakage Current, Forward	$V_{GE}=30V, V_{CE}= 0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GE}= -30V, V_{CE}= 0V$	-	-	-100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}= V_{CE}, I_C= 250\mu A$	4.0	-	6.0	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C= 50A$	-			
		$T_c=25^\circ C$		2.1	2.6	V
		$T_c=125^\circ C$		2.5		V
		$T_c=150^\circ C$		2.8		V
$Q_g$	Total Gate Charge	$V_{CC}=960V$ $V_{GE}=15V$ $I_C=50A$	-	170		nC
$Q_{ge}$	Gate-Emitter Charge		-	40		nC
$Q_{gc}$	Gate-Collector Charge		-	80		nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=50A$ $R_G=10\Omega$ Inductive Load $T_c=25^\circ C$	-	50	-	ns
$t_r$	Turn-on Rise Time		-	80	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	280	-	ns
$t_f$	Turn-off Fall Time		-	30	-	ns
$E_{on}$	Turn-on Switching Loss		-	4.6	-	mJ
$E_{off}$	Turn-off Switching Loss		-	2.8	-	mJ
$E_{ts}$	Total Switching Loss	$V_{CE}=30V$ $V_{GE}=0V$ $f = 1MHz$	-	7.4	-	mJ
$C_{ies}$	Input Capacitance		-	4120	-	pF
$C_{oes}$	Output Capacitance		-	160	-	pF
$C_{res}$	Reverse Transfer Capacitance		-	100	-	pF

## Electrical Characteristics of Diode ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$	Diode Forward Voltage	$I_F=50A$	-	2.3	3.2	V
$t_{rr}$	Diode Reverse Recovery Time	$V_{CE} = 600V$ $I_F= 50A$ $dI_F/dt = 200A/us$	-	250		ns
$I_{rr}$	Diode peak Reverse Recovery Current		-	10		A
$Q_{rr}$	Diode Reverse Recovery Charge		-	1350		nC

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



佳恩半导体  
JIAENSEMI

JNG50N120QS1

## Typical Performance Characteristics

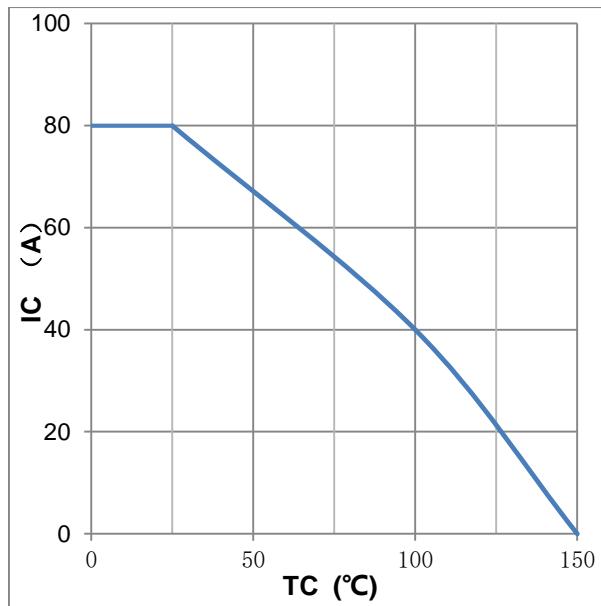


Figure1:maximum DC collector current  
VS. case temprature

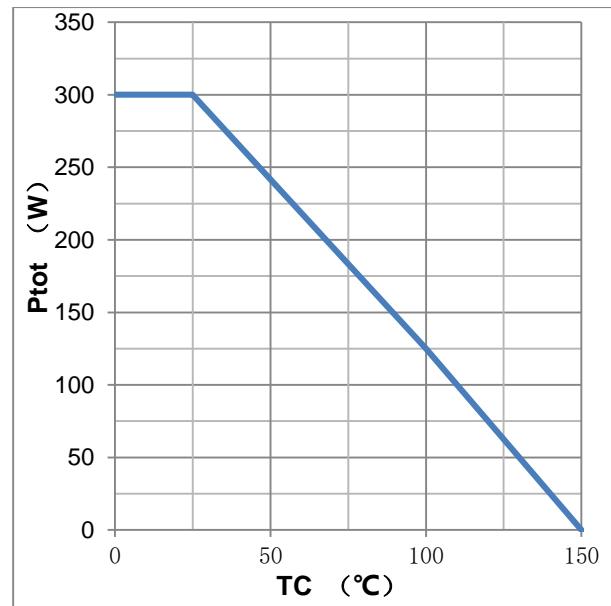


Figure2:power dissipation VS. case temprature

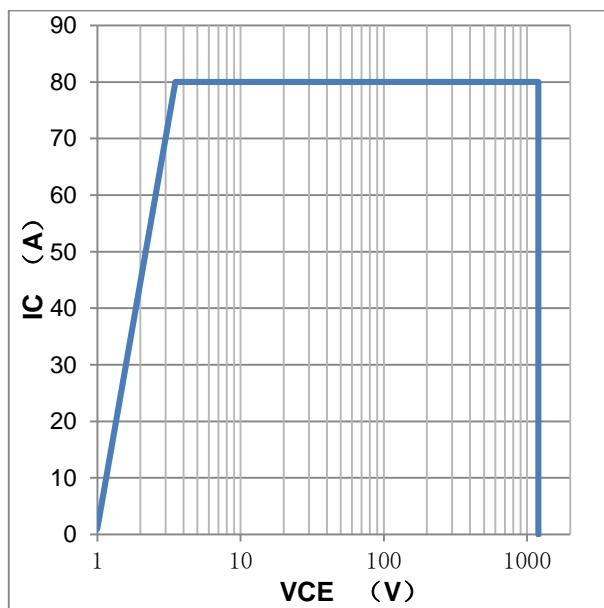


Figure3:reverse bias SOA,TJ=150°C,VGE=15V

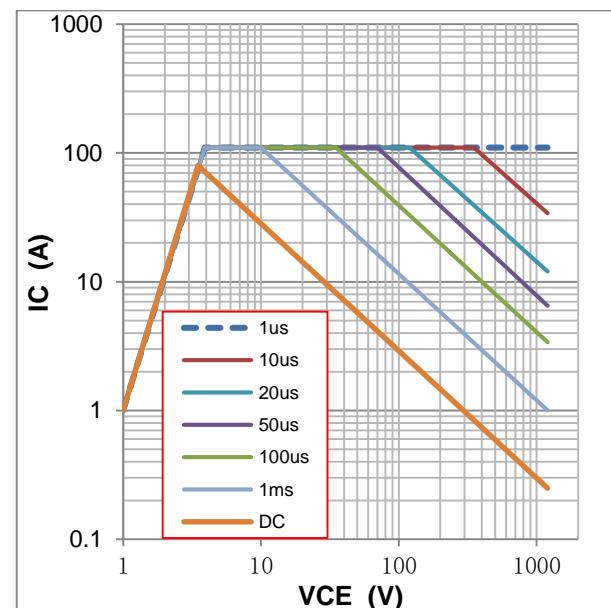


Figure4:forward SOA,TC=25°C,TJ≤150°C

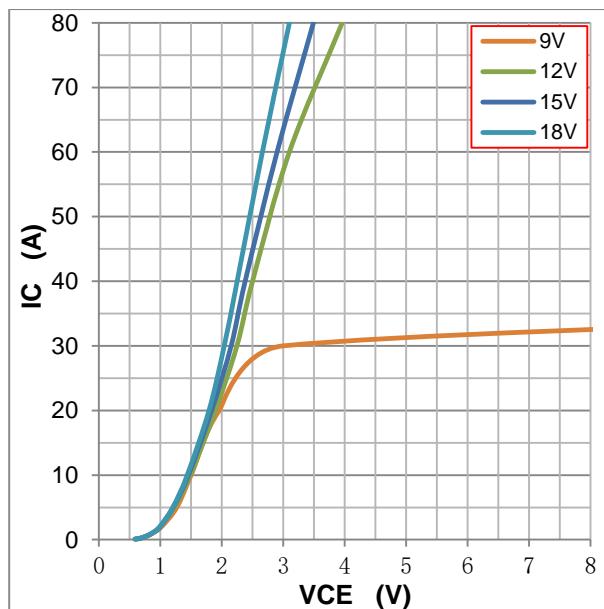


Figure5:typical IGBT output characteristics,  
 $T_J=25^{\circ}\text{C}$ ;tp=300us

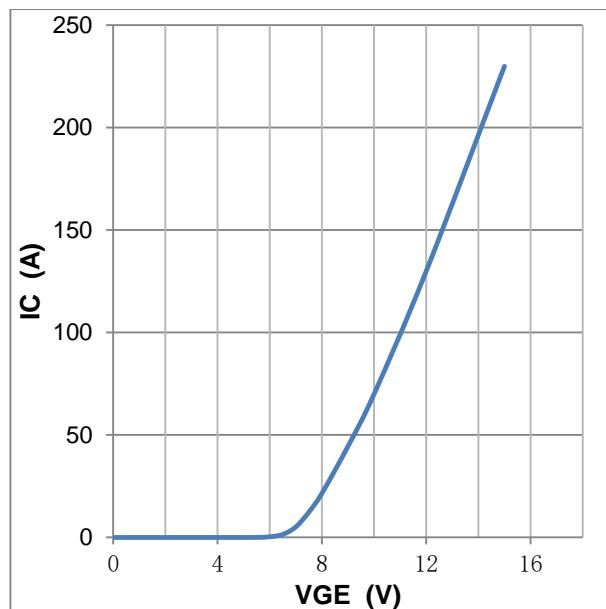


Figure6:typical trans characteristics, $V_{CE}=20\text{V}$ ,tp=20us

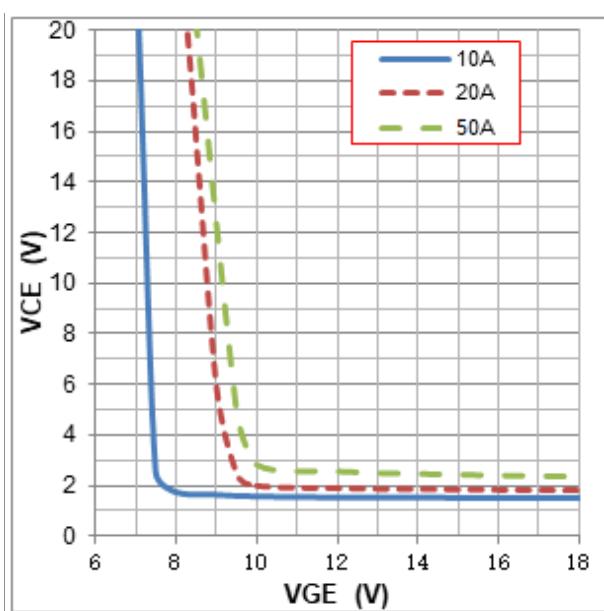


Figure7: typical  $V_{CE}$  VS.  $V_{GE}$ , $T_J=25^{\circ}\text{C}$

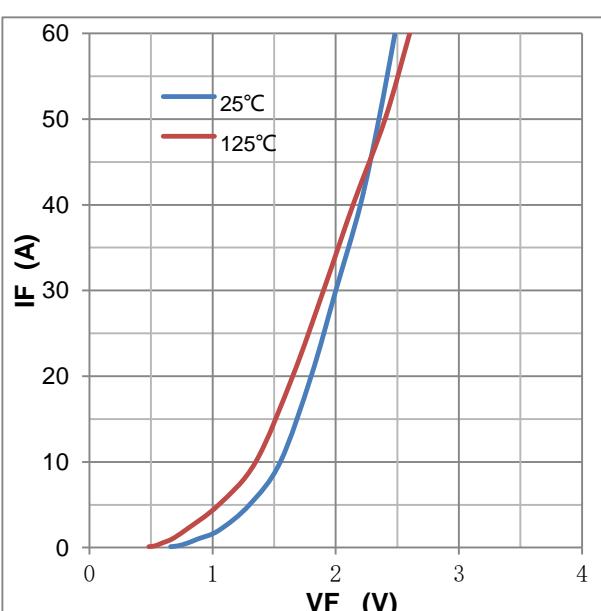


Figure8:typical diode forward characteristic, tp=300us

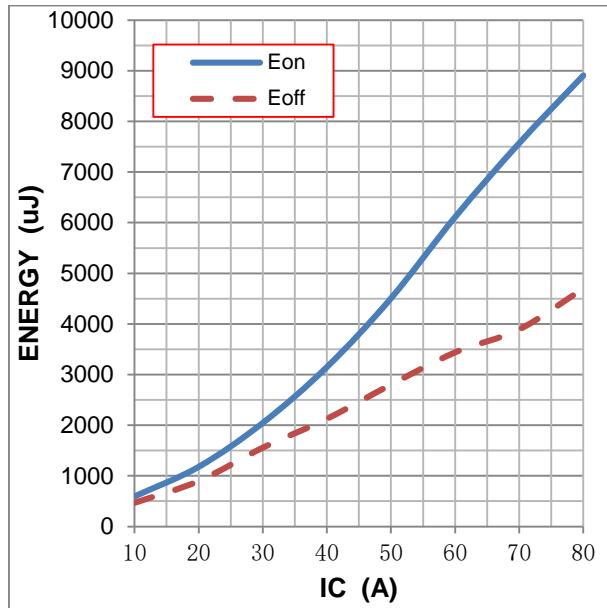


Figure9: typical energy loss VS. IC, TC=25°C,

L=500uH, VCE=600V, VGE=15V, Rg=28Ω

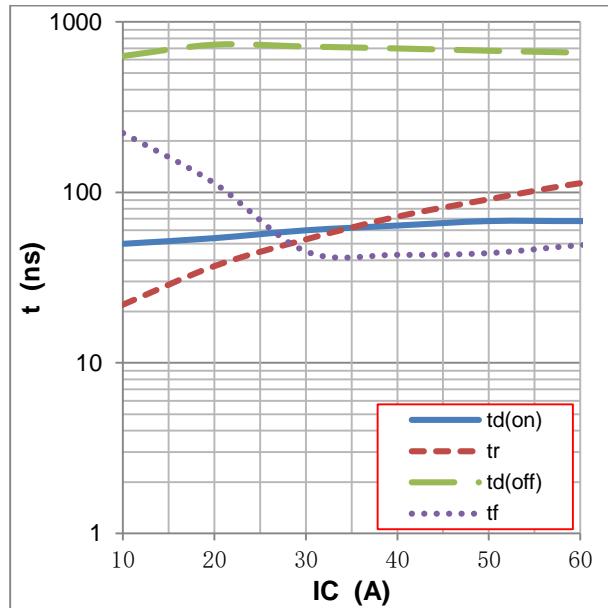


Figure10: typical switching time VS. IC, TC=25°C,

L=500uH, VCE=600V, VGE=15V, Rg=28Ω

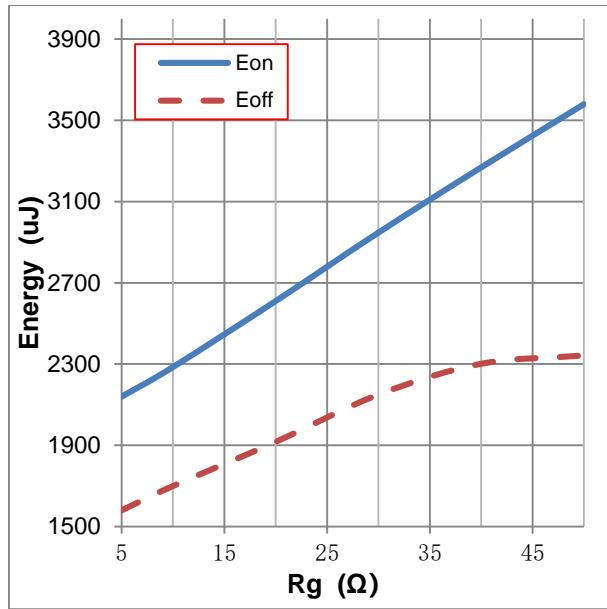


Figure11: typical energy loss VS. Rg, TC=25°C,

L=500uH, VCE=600V, VGE=15V, IC=50A

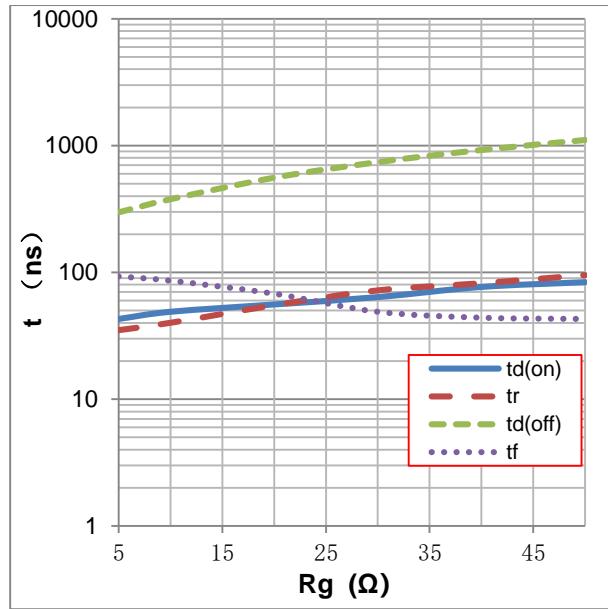
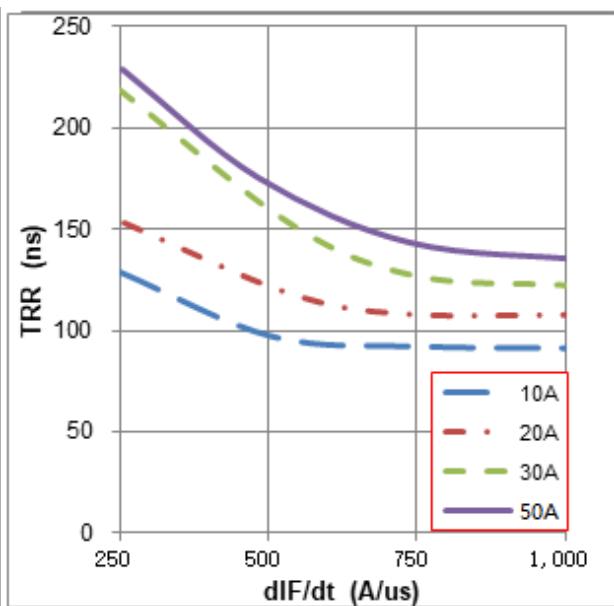
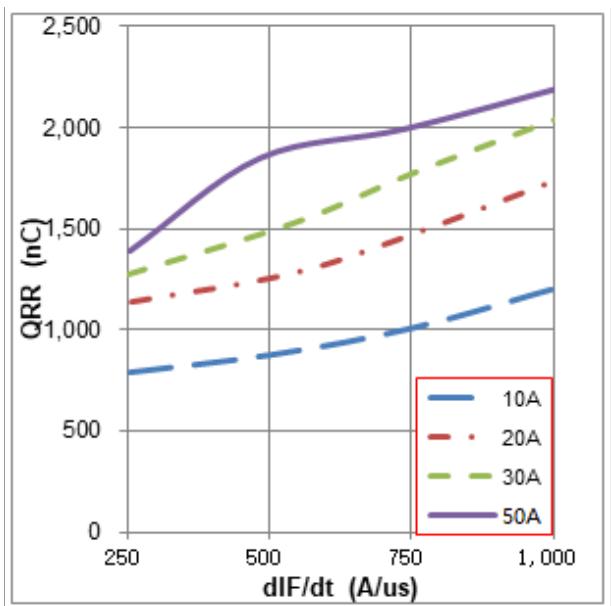
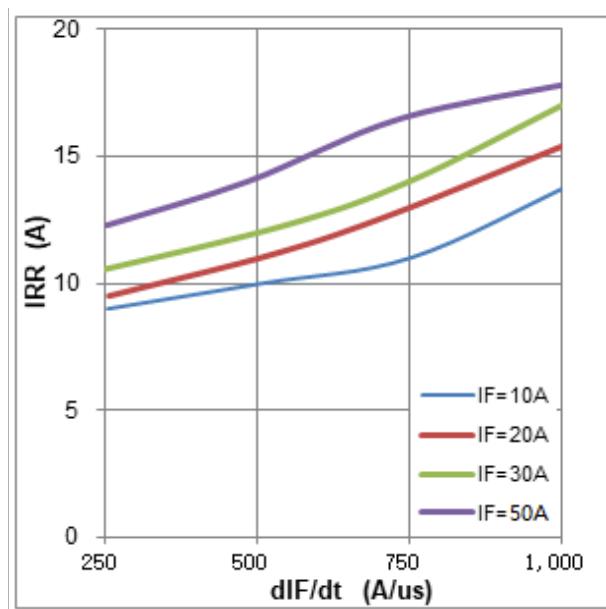
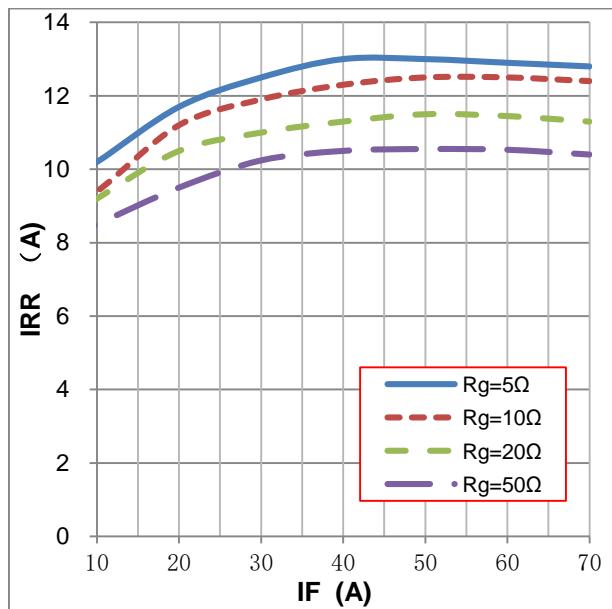
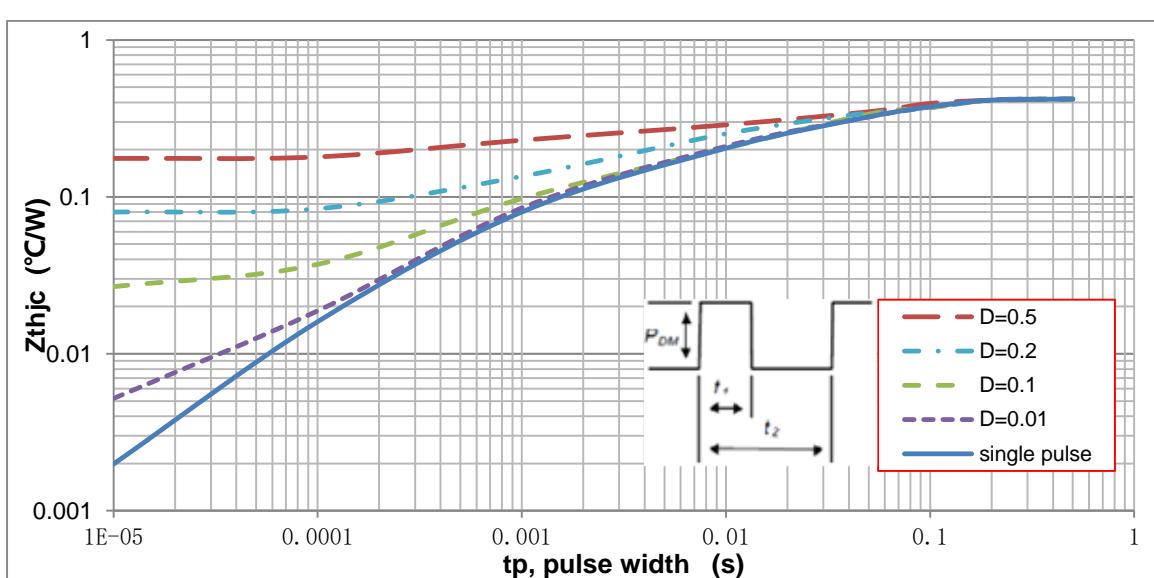
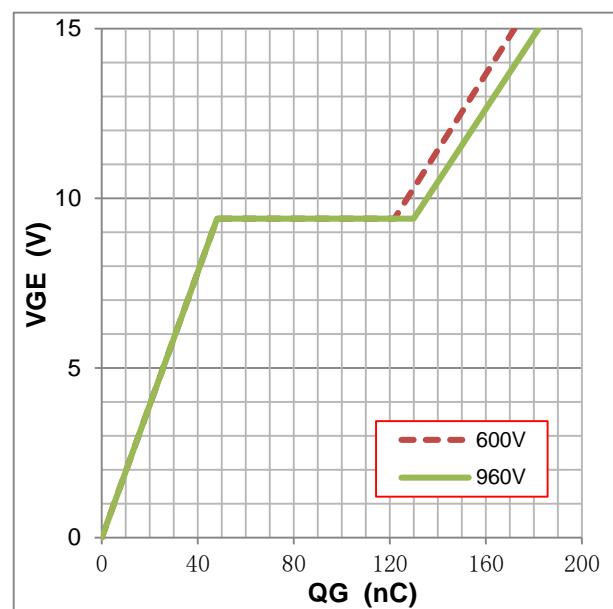
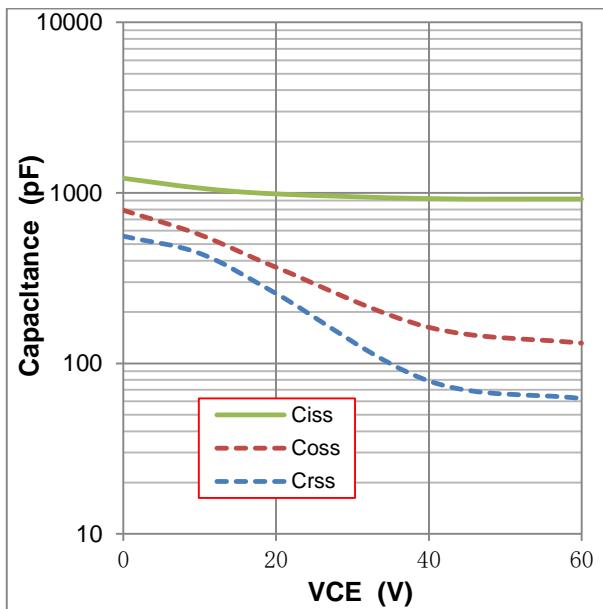


Figure12: typical switching time VS. Rg, TC=25°C,

L=500uH, VCE=600V, VGE=15V, IC=50A



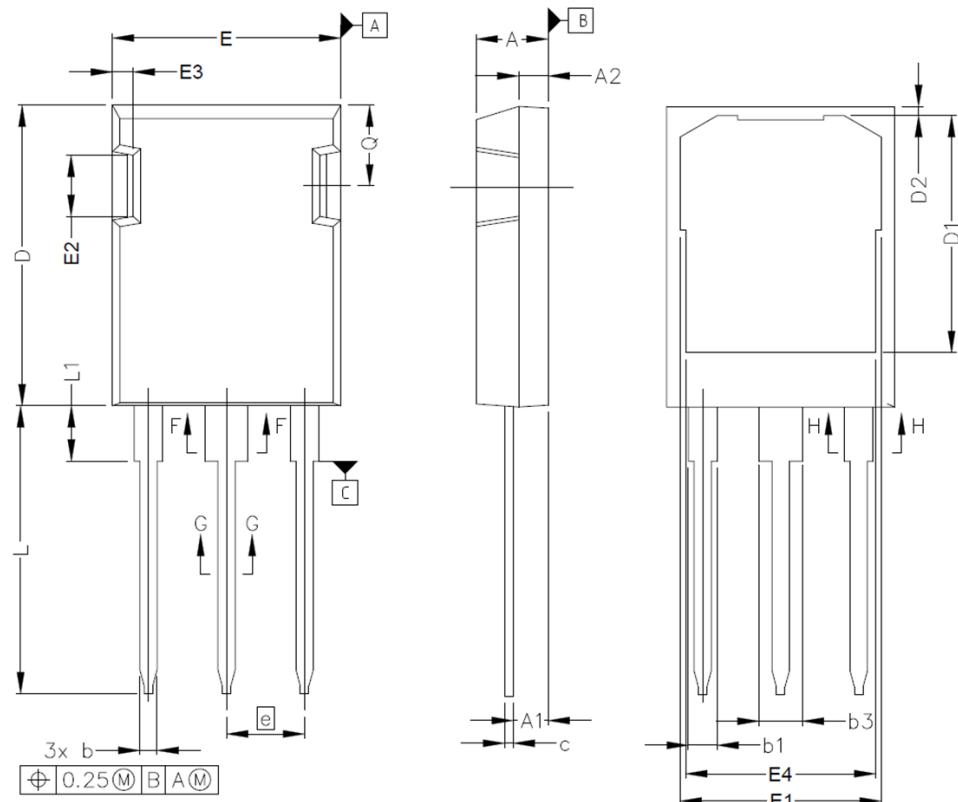


Note1.Duty factor  $D = t_1/t_2$ ;

Note2:peak  $T_J = PDM \times Z_{thjc} + T_C$



## 封装外形



SYMBOL	MIN	MAX
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b'	1.07	1.28
b	1.07	1.33
b1	1.91	2.41
b2	1.91	2.16
b3	2.87	3.38
b4	2.87	3.13
c'	0.55	0.65
c	0.55	0.68
D	20.80	21.10
D1	16.25	17.65
D2	0.50	0.80

SYMBOL	MIN	MAX
E	15.75	16.13
E1	13.10	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
e	5.44 BSC	
N		3
L	19.81	20.32
L1	3.70	4.00
Q	5.49	6.00

## **Disclaimers**

JIAEN Semiconductor Co., Ltd reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information is current and complete. All products are sold subject to JIAEN's terms and conditions supplied at the time of order acknowledgement.

JIAEN Semiconductor Co., Ltd warrants performance of its hardware products to the specifications at the time of sale, Testing, reliability and quality control are used to the extent JIAEN deems necessary to support this warrantee. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

JIAEN Semiconductor Co., Ltd does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using JIAEN's components. To minimize risk, customers must provide adequate design and operating safeguards.

JIAEN Semiconductor Co., Ltd does not warrant or convey any license either expressed or implied under its parent rights, nor the rights of others. Reproduction of information in JIAEN's datasheets or data books sis permissible only if reproduction is without modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice. JIAEN Semiconductor Co., Ltd is not responsible or liable for such altered documentation.

Resale of JIAEN's products with statements different from or beyond the parameters stated by JIAEN Semiconductor Co., Ltd for that product or service voids all express or implied warranties for the associated JIAEN's product or service and is unfair and deceptive business practice. JIAEN Semiconductor Co., Ltd is not responsible or liable for any such statements.